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Bureau Veritas Certification

通富微电子股份有限公司

总部：中国江苏省南通市崇川路 288 号

统一社会信用代码：91320000608319749X

此份为多场所证书，各分场所见证书附页

必维认证集团认证控股有限公司英国分公司

确证上述单位的管理体系已经评审

并确认符合下列管理体系标准全部适用条款的要求

ISO 14001:2015

体系覆盖范围

总范围：大规模集成电路及圆片级的封装、测试和销售

最初认证周期起始日期： 12-07-2013
上一周期的到期日： NA
认证/再认证审核日期： NA
本次认证/再认证周期起始日期： 13-06-2021

在证书持有者之管理体系持续符合要求的运行条件下，本证书至下述日期有效：
11-07-2024

证书号： CNBJ314246-U

版本号： No.2， 发证日期： 11-01-2024



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必维认证集团认证控股有限公司英国分公司
授权代表

认证机构地址： 5th Floor, 66 Prescott Street, London E1 8HG, United Kingdom

当地办公室地址： 必维认证（北京）有限公司，中国北京市东城区东长安街1号东方广场西一办公楼9层902室，邮编：100738

需进一步澄清本证书范围和有效状态，以及此管理体系要求的适用性，请电：+86 10 59683888

获证组织必须定期接受监督审核并经审核合格此证书方继续有效。本证书信息可在国家认证认可监督管理委员会官方网站 (www.cnca.gov.cn) 上查询。



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通富微电子股份有限公司

ISO 14001:2015

体系覆盖范围

场所名称	场所地址	场所认证范围
通富微电子股份有限公司	中国江苏省南通市崇川路 288 号	大规模集成电路及圆片级的封装、测试和销售
南通通富微电子股份有限公司	中国江苏省南通开发区苏通科技产业园江达路 99 号	大规模集成电路的封装和测试
合肥通富微电子股份有限公司	中国安徽省合肥市合肥经济技术开发区卫星路 578 号	大规模集成电路的封装和测试
厦门通富微电子股份有限公司	运营地址：中国福建省厦门市海沧区南海二路 89 号 注册地址：中国（福建）自由贸易试验区厦门片区建港路 29 号海沧国际物流大厦 10 楼 1001 单元 F0193	集成电路的芯片凸块、芯片针测、芯片封装及成品测试，包括金凸块，芯片针测&成品测试，玻璃型封装和卷带式覆晶薄膜封装工艺
通富通科(南通)微电子股份有限公司	中国江苏省南通市通京大道 226 号	大规模集成电路的封装和测试

证书号：CNBJ314246-U

版本号：No.2， 发证日期：11-01-2024

必维认证集团认证控股有限公司英国分公司
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TONGFU MICROELECTRONICS CO., LTD.

HEAD OFFICE: NO. 288, CHONGCHUAN ROAD, NANTONG CITY, JIANGSU PROVINCE, P. R. CHINA

Unified social credit code: 91320000608319749X

This is a multi-site certificate, additional site(s) are listed on the next page(s).

Bureau Veritas Certification Holding SAS - UK Branch certifies that the Management System of the above organisation has been audited and found to be in accordance with the requirements of the management system standards detailed below

ISO 14001:2015

Scope of certification

Overall: Assembly, Testing and Marketing of Large Scale Integrated Circuit and Wafer Level Package Services

Original cycle start date:	12-07-2013
Expiry date of previous cycle:	NA
Certification / Recertification audit date:	NA
Certification / Recertification cycle start date:	13-06-2021

Subject to the continued satisfactory operation of the organisation's Management System, this certificate expires on: **11-07-2024**

Certificate No.: **CNBJ314246-U**

Version: **No.2**, Issue date: **11-01-2024**

Signed on behalf of BVCH SAS UK Branch



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Certification body address: 5th Floor, 66 Prescot Street, London E1 8HG, United Kingdom

Local office address: Bureau Veritas Certification (Beijing) Co., Ltd, Room 02, 9 / F, West Office Building 1, Oriental Economic and Trade City, Oriental Plaza, No.1 East Chang'an Street, Dongcheng District, Beijing, China. 100738

Further clarifications regarding the scope and validity of this certificate, and the applicability of the management system requirements, please call: +86 10 59683888

Certified organisation has to accept and pass regular surveillance audits, then this certificate can be continuously valid. Information of this certificate may be obtained by visiting CNCA website (www.cnca.gov.cn).



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TONGFU MICROELECTRONICS CO., LTD.

ISO 14001:2015

Scope of certification

Site Name/Location	Site Address	Site Scope
TONGFU MICROELECTRONICS CO., LTD.	NO. 288, CHONGCHUAN ROAD, NANTONG CITY, JIANGSU PROVINCE, P. R. CHINA	Assembly, Testing and Marketing of Large Scale Integrated Circuit and Wafer Level Package Services
NANTONG TONGFU MICROELECTRONICS CO., LTD.	NO. 99, JIANGDA ROAD, SU-TONG SCIENCE AND TECHNOLOGY PARK, NANTONG CITY, JIANGSU PROVINCE, P. R. CHINA	Assembly and Testing of Large Scale Integrated Circuit Package
HEFEI TONGFU MICROELECTRONICS CO., LTD.	NO. 578, WEIXING ROAD, HEFEI ECONOMIC AND TECHNOLOGICAL DEVELOPMENT AREA, HEFEI CITY, ANHUI PROVINCE, P. R. CHINA	Assembly and Testing of Large Scale Integrated Circuit Package
XIAMEN TONGFU MICROELECTRONICS CO., LTD.	OPERATION ADDRESS: NO.89, 2ND NANHAI ROAD, HAICANG DISTRICT, XIAMEN CITY, FUJIAN PROVINCE, P. R. CHINA REGISTERED ADDRESS: F0193, NO. 1001 UNIT 10TH FLOOR, HAICANG INTERNATIONAL LOGISTICS BUILDING, NO. 29 JIANGANG ROAD, XIAMEN AREA, CHINA (FU JIAN) PILOT FREE TRADE ZONE, P. R. CHINA	Wafer Bumping, Circuit Probing, Assembly and Testing of Integrated Circuit, Including Gold Bumping, Circuit Probing & Testing, Chip On Glass and Chip On Film process
Tongfu Tongke (Nantong)Microelectronics Co., LTD.	No.226, Tongjing Avenue, Nantong City, Jiangsu Province, P.R.China	Assembly and Testing of Large Scale Integrated Circuit

Certificate No.: CNBJ314246-U

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